

1

DATA SHEET

CX65104: 700 – 1000 MHz Linear Power Amplifier

Applications

- AMPS/CDMA/TDMA/GSM
- Repeaters
- WLL and ISM bands
- Mobile radio
- Paging
- Telematics

Features

- Typical Pout of 31 dBm
- · High linearity
- Low power consumption
- Single +5 V supply
- 8-pin LCC 8 x 8 mm package

Description

Skyworks CX65104 Power Amplifier (PA) is a fully matched, 8-pin Leadless Chip Carrier (LCC) surface mount module, developed for cellular, Wireless Local Loop (WLL), and Industrial, Scientific, Medical (ISM) applications. This small, power-efficient PA has a full 700 to 1000 MHz bandwidth coverage packed into a single compact package.

All active circuitry in the module is contained in a single Gallium Arsenide (GaAs) Microwave Monolithic Integrated Circuit (MMIC). The CX65104 is manufactured with Skyworks Aluminum (Al) GaAs Heterojunction Bipolar Transistor (HBT) process, which allows for single supply operation while maintaining high efficiency and good linearity.

Figure 1 shows a functional block diagram for the CX65104. The device package and pinout are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

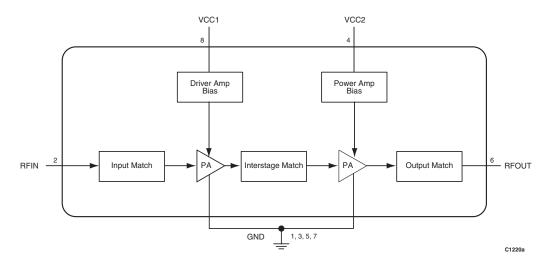


Figure 1. CX65104 Functional Block Diagram

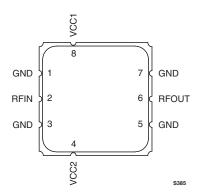


Figure 2. CX65104 Pinout- 8-Pin LCC Package (Top View)

Table 1. CX65104 Signal Descriptions

Pin #	Name	Description	Pin#	Name	Description
1	GND	Ground	5	GND	Ground
2	RFIN	RF input	6	RFOUT	RF output
3	GND	Ground	7	GND	Ground
4	VCC2	Supply voltage	8	VCC1	Supply voltage

Technical Description

The CX65104 is comprised of two amplifier stages. The matching circuits for the input stage, inter-stage, and output stage are contained within the device. The bias circuits for both input and output stages are included within the device for optimum temperature tracking performance.

The CX65104 is internally matched for optimum linearity and efficiency. The input and output stages are independently supplied using the VCC1 and VCC2 supply lines, pins 8 and 4 respectively.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

If the part is attached in a reflow oven, the temperature ramp rate should not exceed 5 °C per second. Maximum temperature should not exceed 225 °C and the time spent at a temperature that exceeds 210 °C should be limited to less than 10 seconds. If the part is manually attached, precaution should be taken to

ensure that the part is not subjected to a temperature that exceeds 300 $^{\circ}$ C for more than 10 seconds.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format. For packaging details, refer to the Skyworks Application Note, *Tape and Reel*, document number 101568.

Electrical and Mechanical Specifications

The absolute maximum ratings of the CX65104 are provided in Table 2. The recommended operating conditions are specified in Table 3 and electrical specifications are provided in Table 4.

Typical performance characteristics over temperature of the CX65104 are illustrated in Figures 3 through 8.

Figure 9 shows the package dimensions for the 8-pin CX65104 LCC and Figure 10 provides the tape and reel dimensions.

Electrostatic Discharge (ESD) Sensitivity

The CX65104 is a static-sensitive electronic device. Do not operate or store near strong electrostatic fields. Take proper ESD precautions.

Table 2. CX65104 Absolute Maximum Ratings

Parameter	Symbol	Min	Typical	Max	Units
RF input power	Pin			10	dBm
Supply voltage	Vcc			8.5	V
Case operating temperature	Tc	-40		+85	°C
Storage temperature	Тѕт	- 55		+125	°C

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal values.

Table 3. CX65104 Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Units
Supply voltage	VCC		5		V
Operating frequency	F ₀	700	900	1000	MHz

Table 4. CX65104 Electrical Characteristics (VCC = 5.0 V, Frequency = 900 MHz, Tc = 25 °C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typical	Max	Units
Analog Inputs						
Frequency range			700	900	1000	MHz
Quiescent current	la			75	100	mA
Small signal gain	G	Pin = −15 dBm	27	29		dB
Output power	Роит	Pin = 3 dBm	29.5	31.0		dBm
Efficiency	PAE	PIN = 3 dBm	35	39		%
Noise Figure (NF)	NF			4	5	dB
Output IP3	OIP3	Two tones with 100 kHz spacing, $P_{IN} = -5$ dBm per tone	37	42		dBm
Pouт @ ACPR = -45 dBc	Pout_acpr	f = 881.5 MHz, 750 kHz offset	23	25		dBm

Note: The above specifications apply only to the 900 MHz operating frequency.

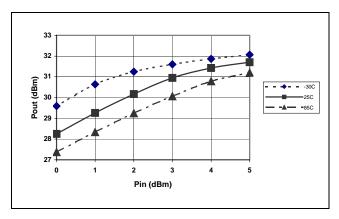


Figure 3. Typical POUT VS PIN Over Temperature

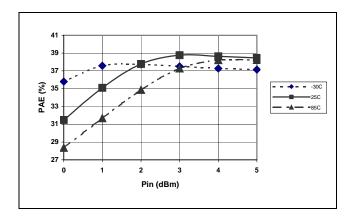


Figure 4. Typical PAE vs PIN Over Temperature

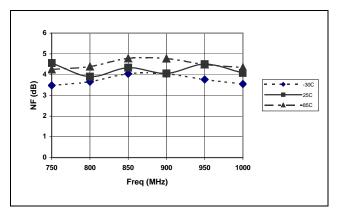


Figure 5. Typical Noise Figure vs Frequency Over Temperature

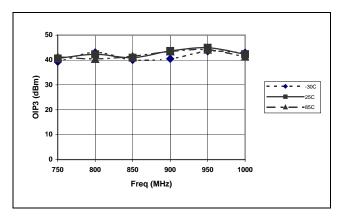


Figure 6. Typical OIP3 vs Frequency Over Temperature

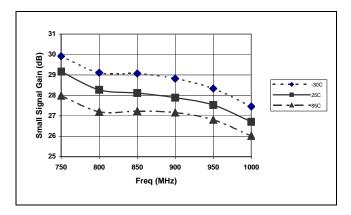


Figure 7. Typical Small Signal Gain vs Frequency Over Temperature

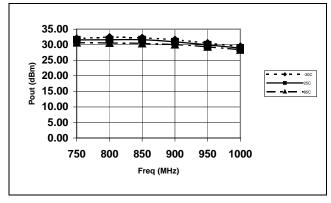


Figure 8. Typical Pout vs Frequency Over Temperature

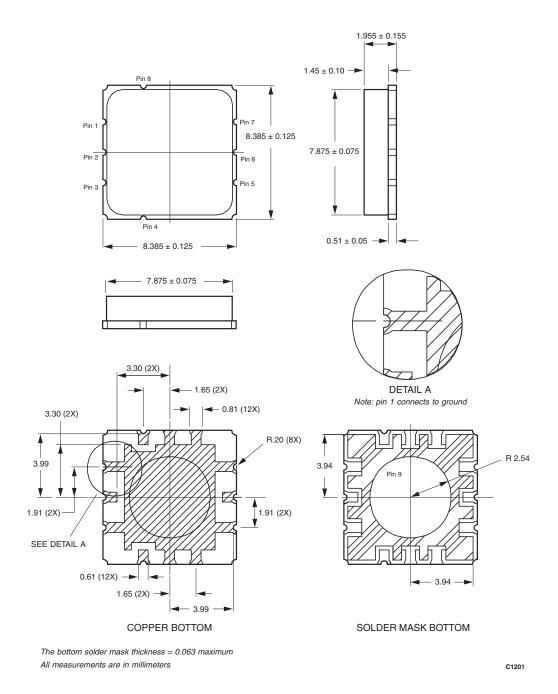


Figure 9. CX65104 8-Pin LCC Package Dimensions

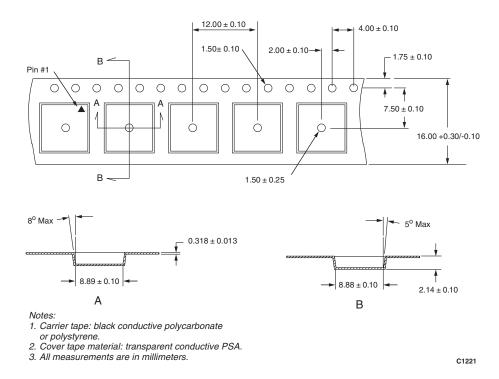


Figure 10. CX65104 8-Pin LCC Tape and Reel Dimensions

Evaluation Board Description

Skyworks CX65104 Evaluation Board is used to test the performance of the CX65104 PA. The Evaluation Board schematic diagram is shown in Figure 11. The schematic shows the basic design of the board for the 700 to 1000 MHz range. Figure 12 provides the Evaluation Board assembly diagram. Figure 13 provides the Evaluation Board layer detail.

Circuit Design Considerations

The following design considerations are general in nature and must be followed regardless of final use or configuration

- 1. Paths to ground should be made as short as possible.
- 2. The ground pad of the CX65104 PA has special electrical and thermal grounding requirements. This pad is the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the amplifier. As such, design the connection to the ground pad to dissipate the maximum wattage produced to the circuit board. Multiple vias to the grounding layer are required.
- 3. Two external output bypass capacitors (0.01 μ F, and 4.7 μ F) are required on the VCC1 (pin 8) supply input. The same three capacitors are also required on the VCC2 (pin 4) supply input. All three capacitors should be placed in parallel between the supply line and ground. See Figure 11 for a detailed diagram.

- 4. VCC1 (pin 8) and VCC2 (pin 4) may be connected together at the supply.
- 5. The RF output includes an onboard internal DC blocking capacitor. All impedance matching is provided internally. Therefore, the application only needs to provide a good 50 Ω load.

Testing Procedure

Use the following procedure to set up the CX65104 Evaluation Board for testing. Refer to Figure 14 for guidance:

- 1. Connect a +5.0 V supply voltage to VCC1 and VCC2. If available, enable the current limiting function of the power supply to 1.0 A.
- Connect a signal generator to the RF signal input port. Set it to the desired RF frequency at a power level of 3 dBm or less to the Evaluation Board but do NOT enable the RF signal.
- 3. Connect a spectrum analyzer to the RF signal output port.
- 4. Enable the power supply.
- 5. Enable the RF signal.
- Take measurements.

CAUTION: If the input signal exceeds the rated power, the CX65104 Evaluation Board can be permanently damaged.

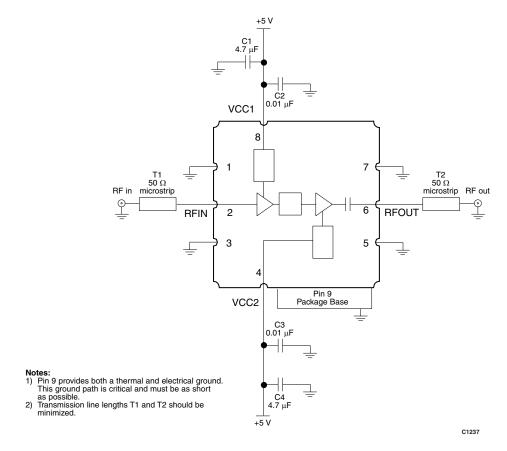


Figure 11. Evaluation Board Schematic, 700 MHz to 1000 MHz

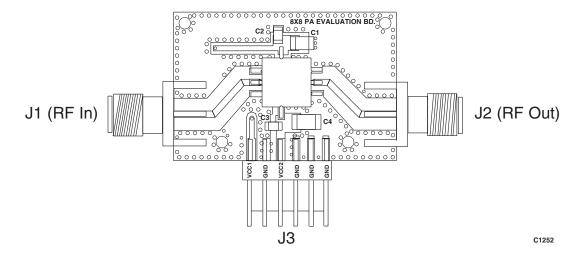
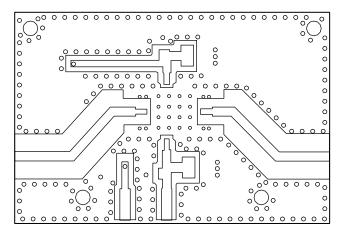
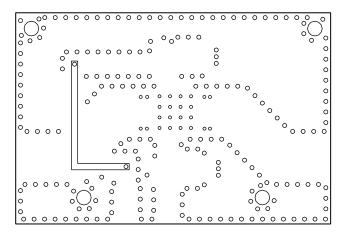


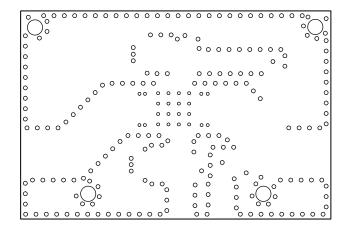
Figure 12. Evaluation Board Assembly Diagram



Layer 1: Top - Metal



Layer 2: Inner Traces



Layer 3: Solid Ground Plane

C1253

Figure 13. Evaluation Board Layer Detail

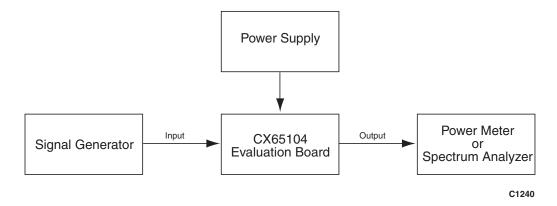


Figure 14. CX65104 Evaluation Board Testing Configuration

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Kit Part Number
CX65104 700-1000 MHz Linear Power Amplifier	CX65104-11	TW10-D832

Copyright © 2001, 2002, 2004, Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc. ("Skyworks") products. These materials are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials. Skyworks may make changes to its documentation, products, specifications and product descriptions at any time, without notice. Skyworks makes no commitment to update the information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from future changes to its documentation, products, specifications and product descriptions.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by or under this document. Except as may be provided in Skyworks Terms and Conditions of Sale for such products, Skyworks assumes no liability whatsoever in association with its documentation, products, specifications and product descriptions.

THESE MATERIALS ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, EITHER EXPRESS OR IMPLIED OR OTHERWISE, RELATING TO SALE AND/OR USE OF SKYWORKS PRODUCTS INCLUDING WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. SKYWORKS FURTHER DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THESE MATERIALS WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not intended for use in medical, lifesaving or life-sustaining applications. Skyworks customers using or selling Skyworks products for use in such applications do so at their own risk and agree to fully indemnify Skyworks for any damages resulting from such improper use or sale.

The following are trademarks of Skyworks Solutions, Inc.: Skyworks™, the Skyworks logo, and Breakthrough Simplicity™. Product names or services listed in this publication are for identification purposes only, and may be trademarks of Skyworks or other third parties. Third-party brands and names are the property of their respective owners. Additional information, posted at www.skyworksinc.com. is incorporated by reference.